FAIRCHILD

SEMICONDUCTOR[®]

FQP17P06 P-Channel QFET[®] MOSFET - 60 V, - 17 A, 120 mΩ

Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

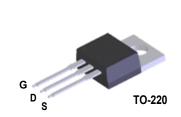
Features

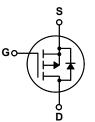
- 17 A, - 60 V, $\mathsf{R}_{DS(on)}$ = 120 m Ω (Max.) @ V_{GS} = - 10 V, ID = - 8.5 A

FQP17P06 P-Channel QFET[®] MOSFET

March 2013

- Low Gate Charge (Typ.21 nC)
- Low Crss (Typ. 80 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





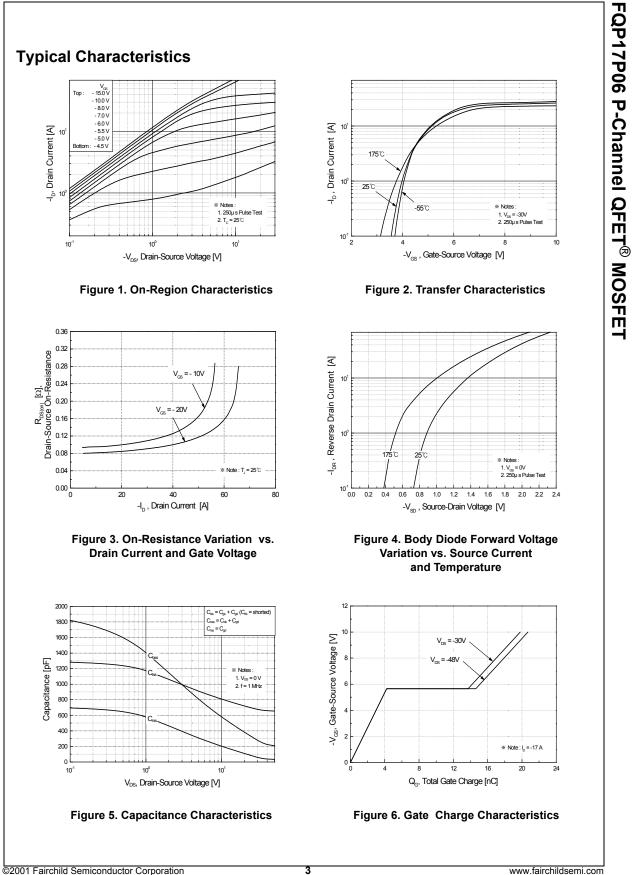
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQP17P06	Unit	
V _{DSS}	Drain-Source Voltage Drain Current - Continuous (T _C = 25°C)			-60	V
I _D			°C)	-17	A
		- Continuous (T _C = 10	O°C)	-12	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	-68	А
V _{GSS}	Gate-Source Voltage			± 25	V
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	300	mJ
I _{AR}	Avalanche Current		(Note 1)	-17	Α
E _{AR}	Repetitive Avalanche Energy		(Note 1)	7.9	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	-7.0	V/ns
PD	Power Dissipation (T _C = 25°C)			79	W
	- Derate above 25°C			0.53	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
ΤL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds			300	°C
'L				500	C

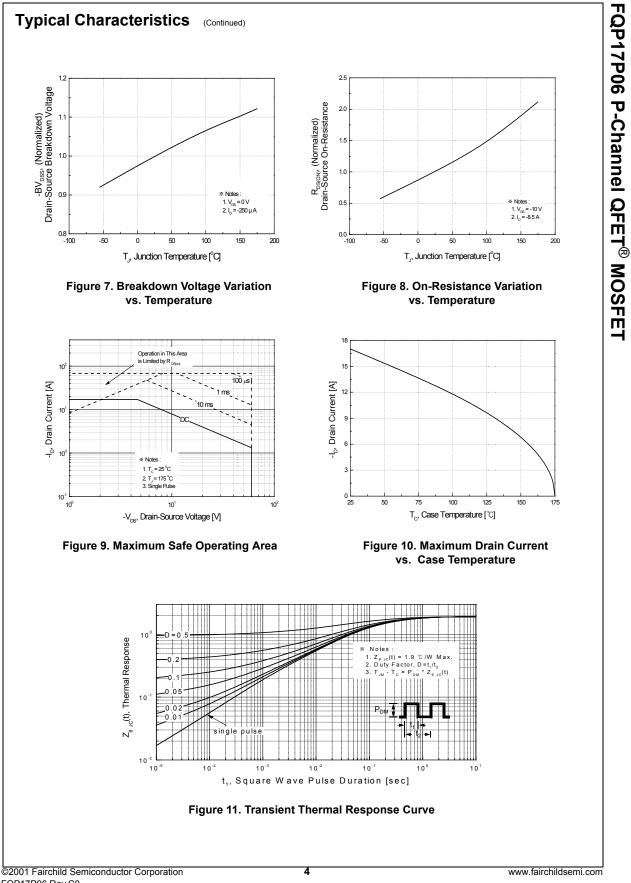
Thermal Characteristics

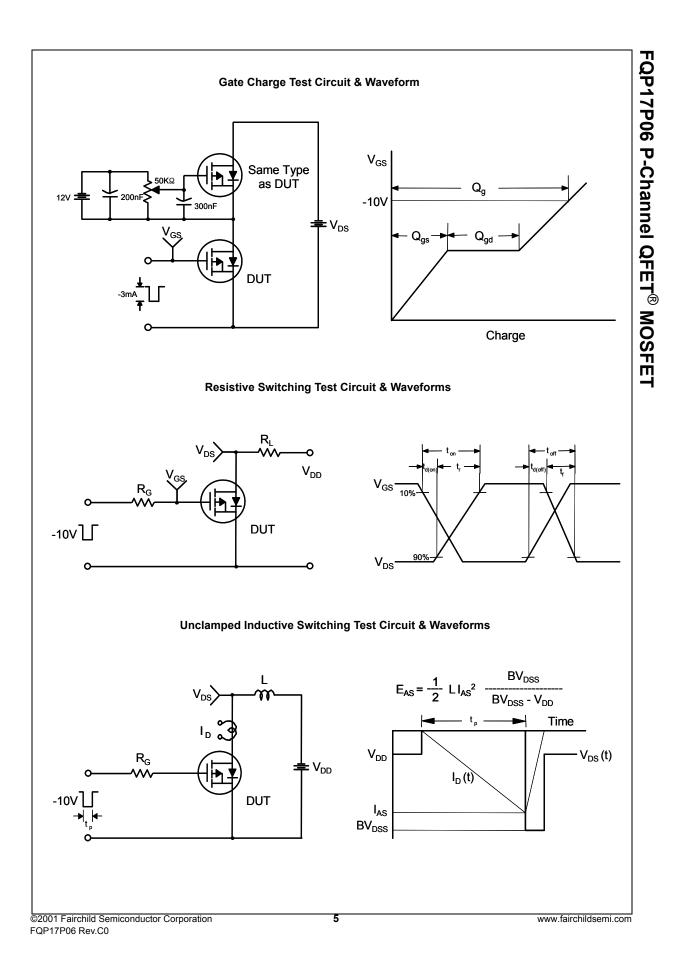
Symbol	Parameter	FQP17P06	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	1.9	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

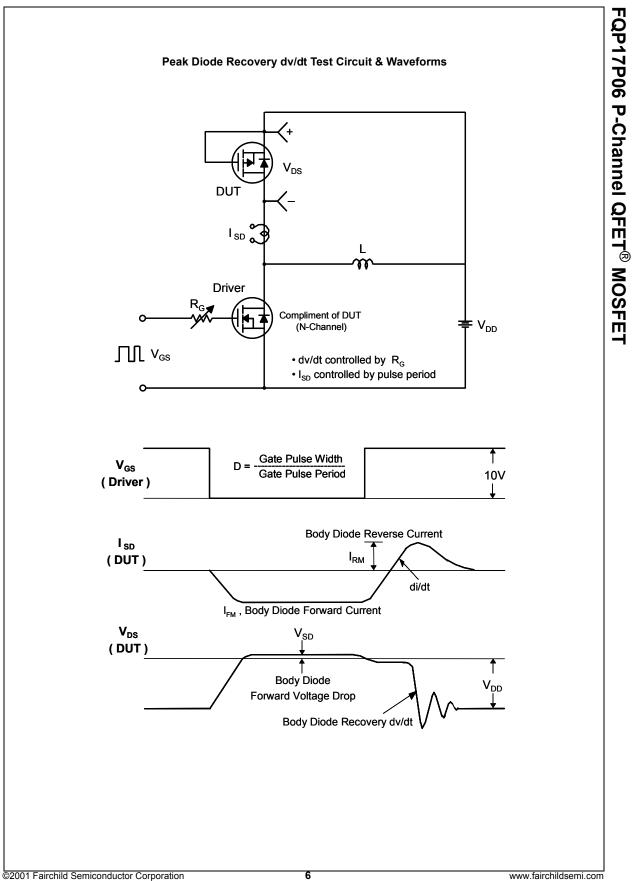
	Parameter	Test Conditions	Min	Тур	Мах	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-60			V
ΔBV _{DSS} / ΔΤ.	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-0.06		V/°C
I _{DSS}		V _{DS} = -60 V, V _{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 150°C			-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward V _{GS} = -25 V, V _{DS} = 0 V				-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 25 V, V_{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source $V_{GS} = -10 \text{ V}, \text{ I}_D = -8.5 \text{ A}$ On-Resistance $V_{GS} = -10 \text{ V}, \text{ I}_D = -8.5 \text{ A}$			0.094	0.12	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -30 V, I _D = -8.5 A		9.3		S
C _{iss}	Input Capacitance	$V_{\rm DS}$ = -25 V, $V_{\rm GS}$ = 0 V,		690	900	pF
	ic Characteristics			690	900	nE
		f = 1.0 MHz		205	400	-
C _{oss}	Output Capacitance	f = 1.0 MHz		325	420	pF
	Reverse Transfer Capacitance	f = 1.0 MHz		325 80	420 105	p⊦ pF
C _{rss} Switchi	Reverse Transfer Capacitance ng Characteristics	f = 1.0 MHz		80	105	pF
C _{rss} Switchi	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time	f = 1.0 MHz V _{DD} = -30 V, I _D = -8.5 A,		80	105 35	pF ns
C _{rss} Switchi t _{d(on)} t _r	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time			80 13 100	105 35 210	pF ns ns
C_{rss} Switchi $t_{d(on)}$ t_r $t_{d(off)}$	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	V_{DD} = -30 V, I _D = -8.5 A, R _G = 25 Ω		80 13 100 22	105 35 210 55	ns ns ns
$\frac{C_{rss}}{Switchi}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	V_{DD} = -30 V, I _D = -8.5 A, R _G = 25 Ω (Note 4)	 	80 13 100 22 60	105 35 210 55 130	pF ns ns ns ns
$\frac{C_{rss}}{Switchi}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ Q_g	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	V_{DD} = -30 V, I _D = -8.5 A, R _G = 25 Ω (Note 4) V _{DS} = -48 V, I _D = -17 A,		80 13 100 22 60 21	105 35 210 55 130 27	pF ns ns ns nC
$\frac{C_{rss}}{Switchi}$ $\frac{f_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_{gs}}$	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	V_{DD} = -30 V, I _D = -8.5 A, R _G = 25 Ω (Note 4)	 	80 13 100 22 60 21 4.2	105 35 210 55 130 27 	pF ns ns ns nc nC
$\frac{\text{Switchi}}{t_{d(on)}}$ $\frac{t_r}{t_{d(off)}}$ $\frac{t_f}{Q_g}$ Q_{gs} Q_{gd}	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	V_{DD} = -30 V, I _D = -8.5 A, R _G = 25 Ω (Note 4) V_{DS} = -48 V, I _D = -17 A, V _{GS} = -10 V (Note 4)	 	80 13 100 22 60 21	105 35 210 55 130 27	pF ns ns ns nC
C_{rss} Switchi $t_{d(on)}$ t_r $t_{d(off)}$ t_f Q_g Q_{gs} Q_{gd} Drain-S	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an	$V_{DD} = -30 \text{ V, } I_D = -8.5 \text{ A,}$ $R_G = 25 \Omega$ (Note 4) $V_{DS} = -48 \text{ V, } I_D = -17 \text{ A,}$ $V_{GS} = -10 \text{ V}$ (Note 4) (Note 4)	 	80 13 100 22 60 21 4.2 10	105 35 210 55 130 27 	pF ns ns ns nC nC nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_{r}}{t_{d(off)}}$ $\frac{t_{d(off)}}{Q_{gs}}$ Q_{gs} Q_{gd} $Drain-S$	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Dio	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -8.5 \text{ A},$ $R_{G} = 25 \Omega$ (Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_{D} = -17 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) (Note 4) (Note 4) (Note 4)	 	80 13 100 22 60 21 4.2 10 	105 35 210 55 130 27 	pF ns ns ns nC nC nC
C _{rss} Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-S I _S	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and Maximum Continuous Drain-Source Diode F	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -8.5 \text{ A},$ $R_{G} = 25 \Omega$ (Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_{D} = -17 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) (Note 4) (Note 4) (Note 4) (Note 4)	 	80 13 100 22 60 21 4.2 10	105 35 210 55 130 27 	pF ns ns ns nC nC nC A A
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_{r}}{t_{d(off)}}$ $\frac{t_{d(off)}}{Q_{gs}}$ Q_{gs} Q_{gd} $Drain-S$	Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Dio	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -8.5 \text{ A},$ $R_{G} = 25 \Omega$ (Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_{D} = -17 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) (Note 4) (Note 4) (Note 4) (Note 4)	 	80 13 100 22 60 21 4.2 10 	105 35 210 55 130 27 	pF ns ns ns nC nC nC

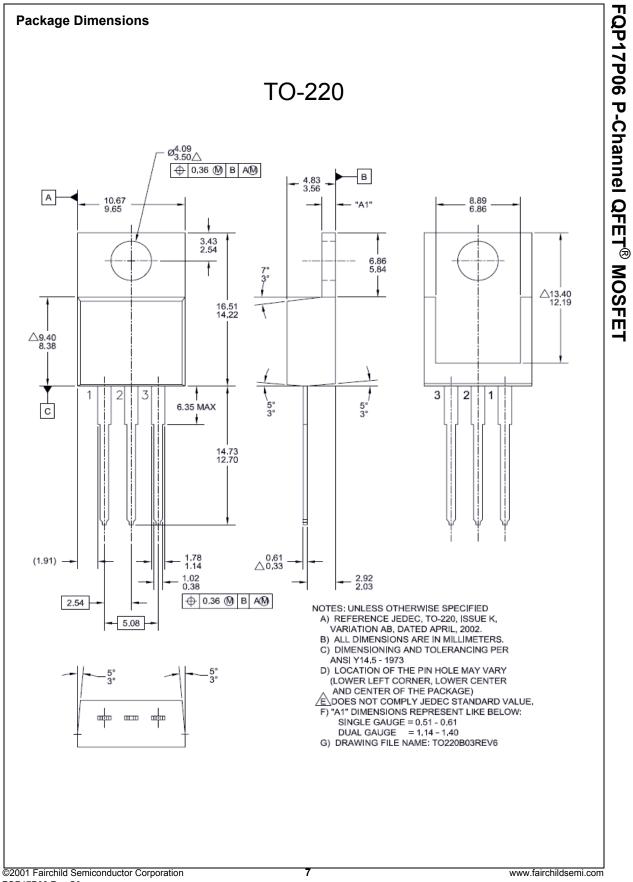


FQP17P06 Rev.C0











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